CRMKTH0706A

N-Channel 68V, 6.3mΩ Typ. Power MOSFET

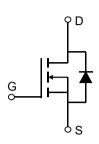
Description

Features

• 68V, 95A

 $R_{DS(ON)}$ Typ = 6.3m Ω @ V_{GS} = 10V

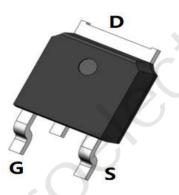
- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

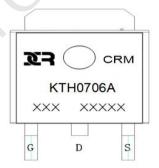




Application

- Load Switch
- PWM Application
- Power Management





Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKTH0706A	CRMKTH0706A	TO-252-3L	TAPING	13"	2500	25000

Absolute Maximum Ratings (@ $T_J = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		68	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	95	А
I _D	Continuous Drain Current	T _C = 100°C	57	Α
I _{DM}	Pulsed Drain Current (1)		380	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		248	mJ
P_{D}	Power Dissipation	T _C = 25°C	125	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		1	°C/W
T_J,T_STG	Junction & Storage Temperature Range		-55 to 150	°C



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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	68	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 68V, V_{GS} = 0V$	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.4	3	3.6	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 10V, I_D = 20A$	-	6.3	8.2	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		- /	4960	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 25V,$ f = 1MHz	-	328	-	pF
C_{rss}	Reverse Transfer Capacitance	1 - 1101112	X - \	203	-	pF
Q_g	Total Gate Charge		-	45	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 30V, I_{D} = 20A$	<u> </u>	17	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V _{DS} - 30 V, I _D - 20A	-	11	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	22	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 30V$	-	80	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	I_D = 30A, R_{GEN} = 3Ω	-	50	-	ns
t _f	Turn-Off Fall Time		-	28	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I _S	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	95	Α
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	380	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 20A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 004 11/11 1004/	-	35	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 30A$, di/dt = 100A/us	-	54	_	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =30V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =31.5A

^{3.} Pulse Test: Pulse Width $\!\!\leqslant\! 300\mu s,$ Duty Cycle $\!\!\leqslant\! 0.5\%.$

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Test Circuit

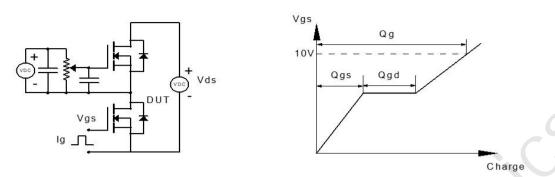


Figure 1: Gate Charge Test Circuit & Waveform

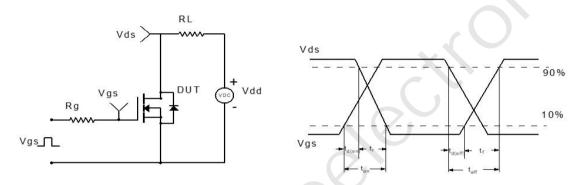


Figure 2: Resistive Switching Test Circuit & Waveform

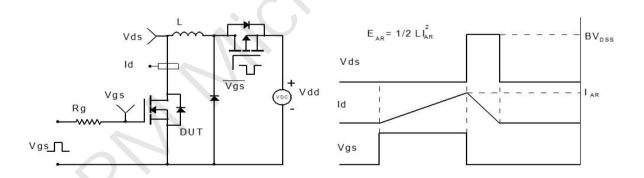


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

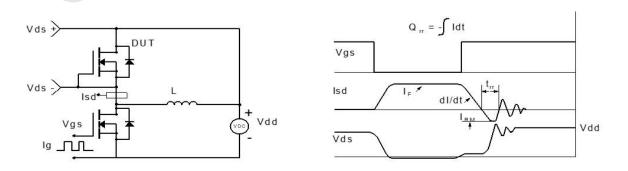
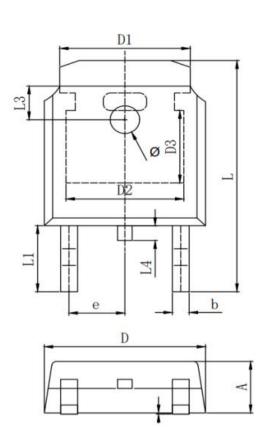


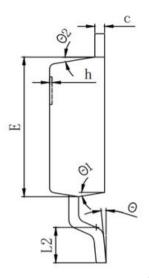
Figure 4: Diode Recovery Test Circuit & Waveform

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Package Mechanical Data(TO-252-3L)





CAMBOI	MILLIMETER				
SYMBOL	MIN	Typ.	MAX		
A	2.200	2.300	2.400		
A1	0.000		0. 127		
b	0.640	0.690	0.740		
(电镀后)	0.460	0.520	0. 580		
D	6.500	6.600	6. 700		
D1	5. 334 REF				
D2	4. 826 REF				
D3	3. 166 REF				
E	6.000	6. 100	6. 200		
e	2. 286 TYP				
h	0.000	0.100	0. 200		
L	9.900	10.100	10.300		
L1	2.888 REF				
L2	1.400	1.550	1.700		
L3	1.600 REF				
L4	0.600	0.800	1.000		
ф	1.100	1.200	1.300		
θ	0°		8°		
θ 1	9° TYP				
θ2	9° TYP				

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